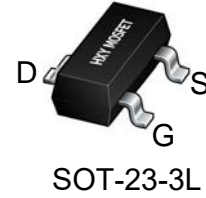




### Description

The SSM3J358R uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

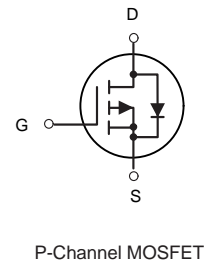


### General Features

$V_{DS} = -20V, I_D = -7A$   
 $R_{DS(ON)} < 26m\Omega @ V_{GS}=4.5V$

### Application

High power and current handing capability  
Lead free product is acquired  
Surface mount package  
PWM applications  
Load switch  
Power management



### Package Marking and Ordering Information

| Product ID | Pack      | Brand      | Qty(PCS) |
|------------|-----------|------------|----------|
| SSM3J358R  | SOT-23-3L | HXY MOSFET | 3000     |

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Symbol          | Parameter  | Limit      | Unit         |
|-----------------|--|------------|--------------|
| $V_{DS}$        | Drain-Source Voltage                             | -20        | V            |
| $V_{GS}$        | Gate-Source Voltage                              | $\pm 12$   | V            |
| $I_D$           | Drain Current-Continuous                         | -7         | A            |
| $I_{DM}$        | Drain Current-Pulsed (Note 1)                    | -18.8      | A            |
| $P_D$           | Maximum Power Dissipation                        | 1          | W            |
| $T_J, T_{STG}$  | Operating Junction and Storage Temperature Range | -55 To 150 | $^\circ C$   |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (Note 2) | 125        | $^\circ C/W$ |



**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

| Symbol                              | Parameter                                      | Conditions   | Min. | Typ.  | Max.  | Unit  |
|-------------------------------------|--|--|------|-------|-------|-------|
| BV <sub>DSS</sub>                   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA   | -20  | ---   | ---   | V     |
| ΔBV <sub>DSS</sub> /ΔT <sub>J</sub> | BVDSS Temperature Coefficient                  | Reference to 25°C , I <sub>D</sub> =-1mA   | ---  | -0.01 | ---   | V/°C  |
| R <sub>DS(ON)</sub>                 | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-6.5A   | ---  | 20    | 26    | mΩ    |
|                                     |  | V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-5A   | ---  | 34    | 40    |       |
|                                     |  | V <sub>GS</sub> =-1.8V , I <sub>D</sub> =-1.5A   | ---  | ---   | ---   |       |
| V <sub>GS(th)</sub>                 | Gate Threshold Voltage                         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA                                    | -0.6 | -0.8  | -1.4  | V     |
| ΔV <sub>GS(th)</sub>                | V <sub>GS(th)</sub> Temperature Coefficient    |  | ---  | ---   | ---   | mV/°C |
| I <sub>DSS</sub>                    | Drain-Source Leakage Current                   | V <sub>DS</sub> =-20V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C                           | ---  | ---   | -1    | uA    |
|                                     |  | V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C                           | ---  | ---   | ---   |       |
| I <sub>GSS</sub>                    | Gate-Source Leakage Current                    | V <sub>GS</sub> =±12V , V <sub>DS</sub> =0V  | ---  | ---   | ±100  | nA    |
| g <sub>fs</sub>                     | Forward Transconductance                       | V <sub>DS</sub> =-5V , I <sub>D</sub> =-3A   | ---  | 10    | ---   | S     |
| Q <sub>g</sub>                      | Total Gate Charge (-4.5V)                      | V <sub>DS</sub> =-10V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-6.5A                       | ---  | 10    | ---   | nC    |
| Q <sub>gs</sub>                     | Gate-Source Charge                             |  | ---  | 1.5   | ---   |       |
| Q <sub>gd</sub>                     | Gate-Drain Charge                              |  | ---  | 3     | ---   |       |
| T <sub>d(on)</sub>                  | Turn-On Delay Time                             | V <sub>DD</sub> =-10V , V <sub>GS</sub> =-4.5V , R <sub>G</sub> =6.0Ω<br>I <sub>D</sub> =-1A | ---  | 30    | ---   | ns    |
| T <sub>r</sub>                      | Rise Time                                      |  | ---  | 25    | ---   |       |
| T <sub>d(off)</sub>                 | Turn-Off Delay Time                            |  | ---  | 70    | ---   |       |
| T <sub>f</sub>                      | Fall Time                                      |  | ---  | 50    | ---   |       |
| C <sub>iss</sub>                    | Input Capacitance                              | V <sub>DS</sub> =-10V , V <sub>GS</sub> =0V , f=1MHz   | ---  | 1210  | ---   | pF    |
| C <sub>oss</sub>                    | Output Capacitance                             |  | ---  | 310   | ---   |       |
| C <sub>rss</sub>                    | Reverse Transfer Capacitance                   |  | ---  | 290   | ---   |       |
| I <sub>S</sub>                      | Continuous Source Current <sup>1,4</sup>       | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current   | ---  | ---   | -7.0  | A     |
| I <sub>SM</sub>                     | Pulsed Source Current <sup>2,4</sup>           |  | ---  | ---   | -18.8 | A     |
| V <sub>SD</sub>                     | Diode Forward Voltage <sup>2</sup>             | V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C                             | ---  | ---   | -1    | V     |
| t <sub>rr</sub>                     | Reverse Recovery Time                          | I <sub>F</sub> =-4A , dI/dt=100A/μs , T <sub>J</sub> =25°C                                   | ---  | 52    | ---   | nS    |
| Q <sub>rr</sub>                     | Reverse Recovery Charge                        |  | ---  | 28    | ---   | nC    |

Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
3. The power dissipation is limited by 150°C junction temperature
4. The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub> , in real applications , should be limited by total power dissipation.



### Typical Characteristics

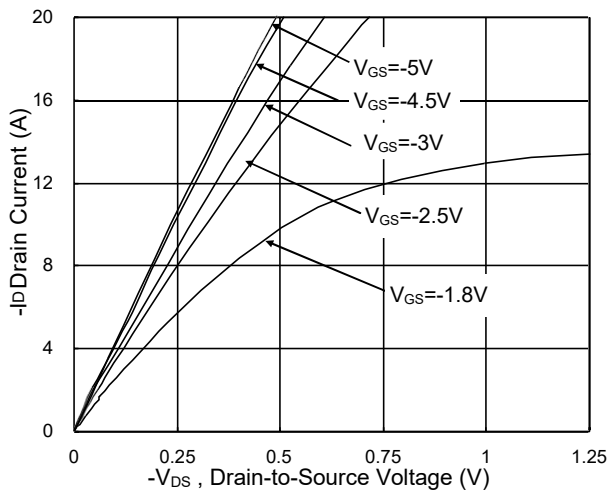


Fig.1 Typical Output Characteristics

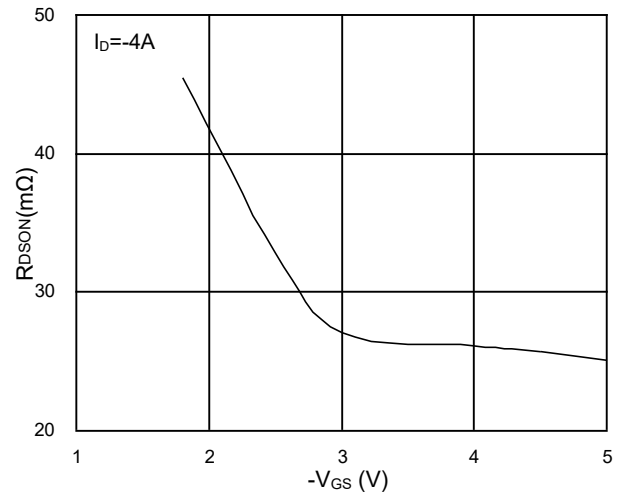


Fig.2 On-Resistance vs. Gate-Source

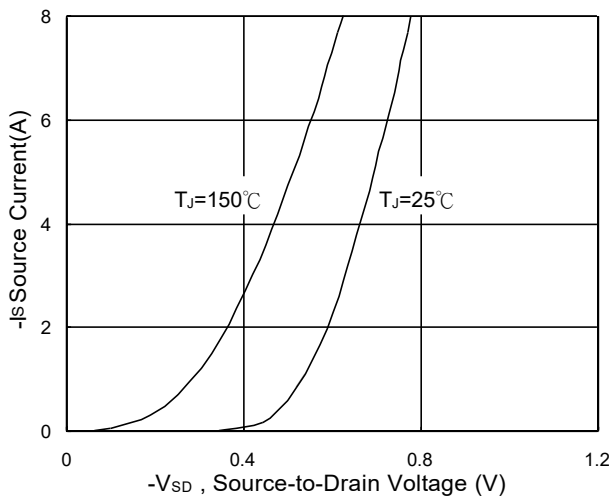


Fig.3 Forward Characteristics Of Reverse

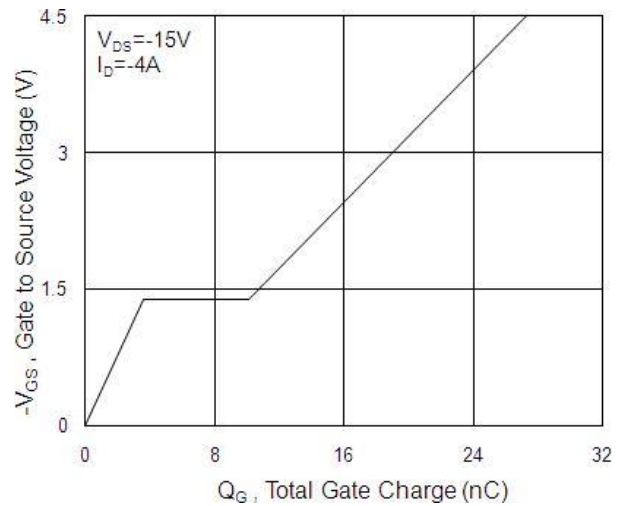


Fig.4 Gate-Charge Characteristics

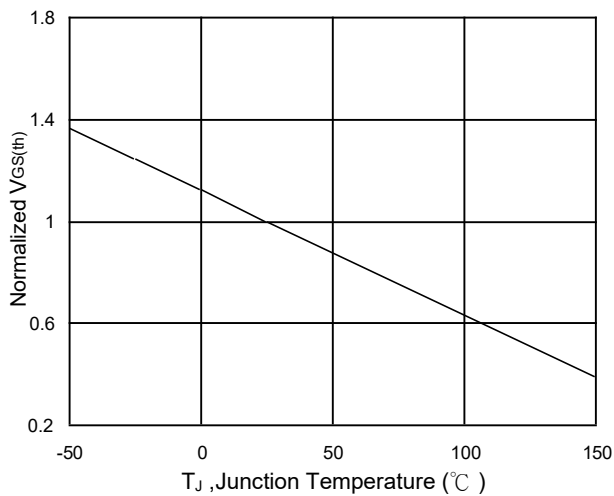


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

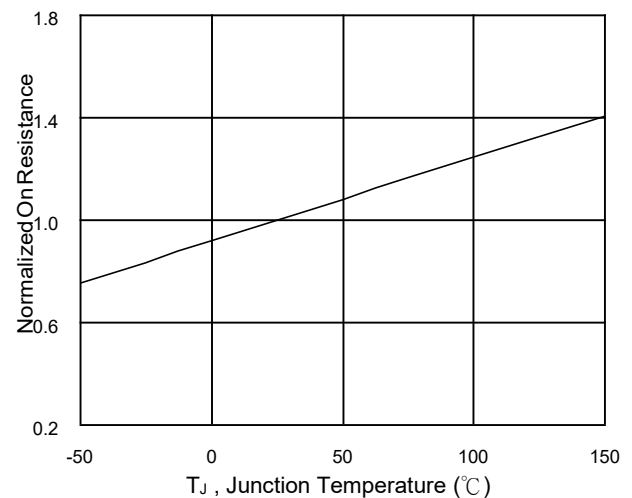


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

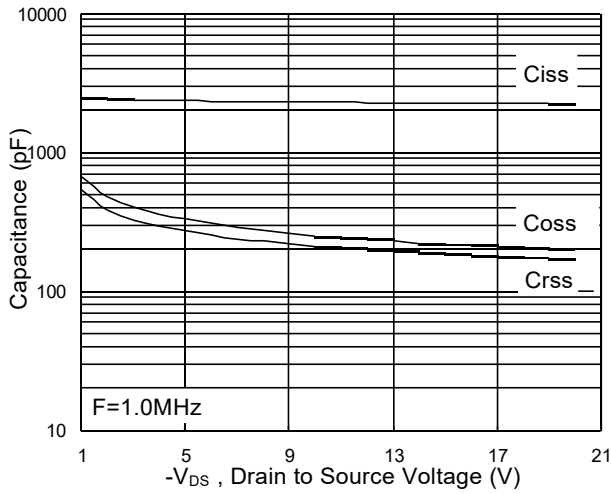


Fig.7 Capacitance

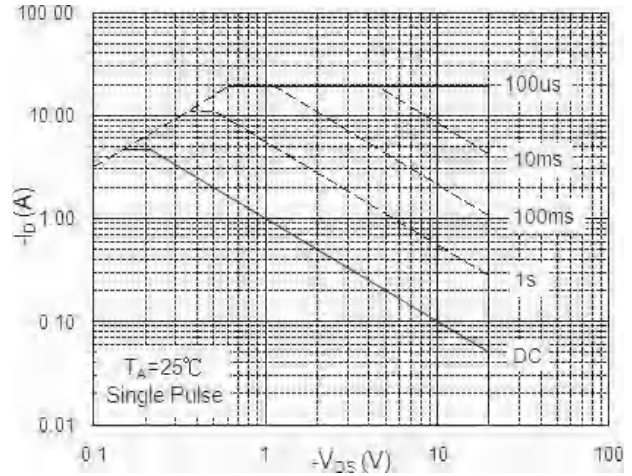


Fig.8 Safe Operating Area

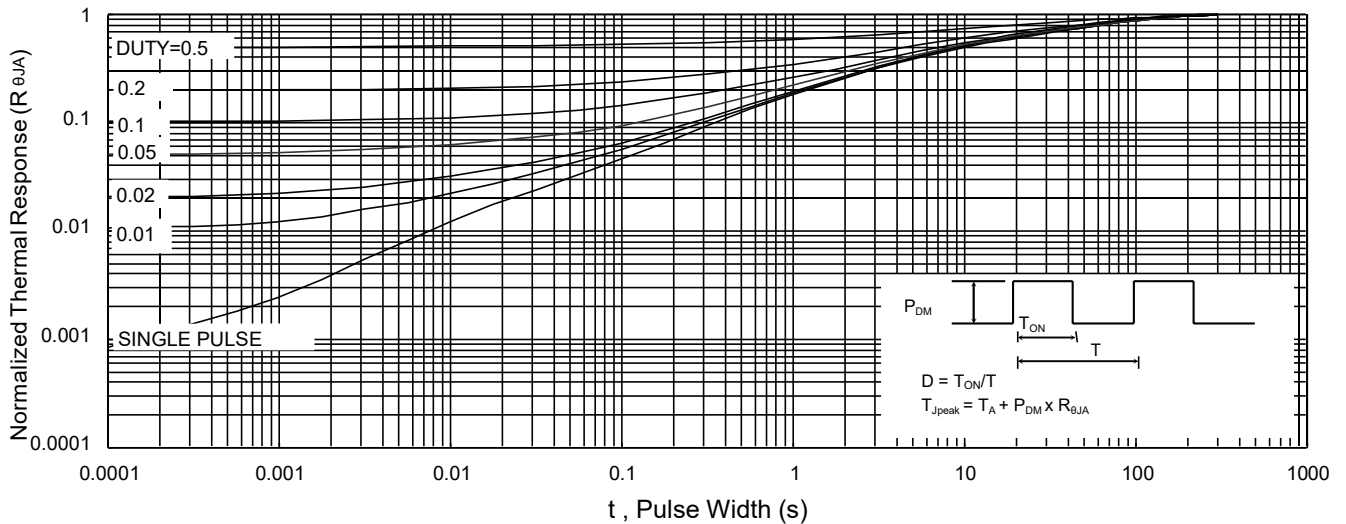


Fig.9 Normalized Maximum Transient Thermal Impedance

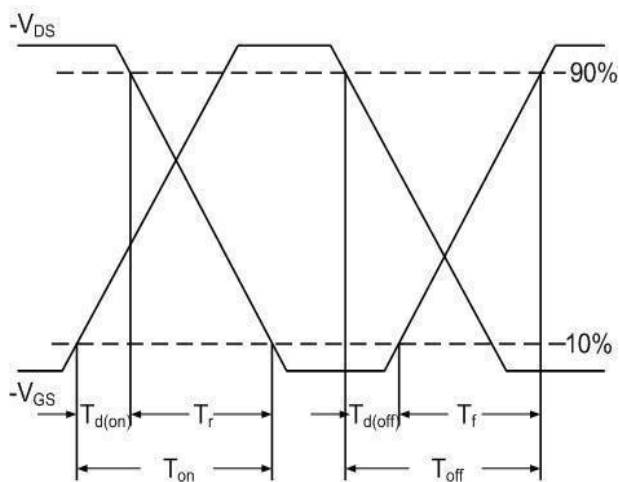


Fig.10 Switching Time Waveform

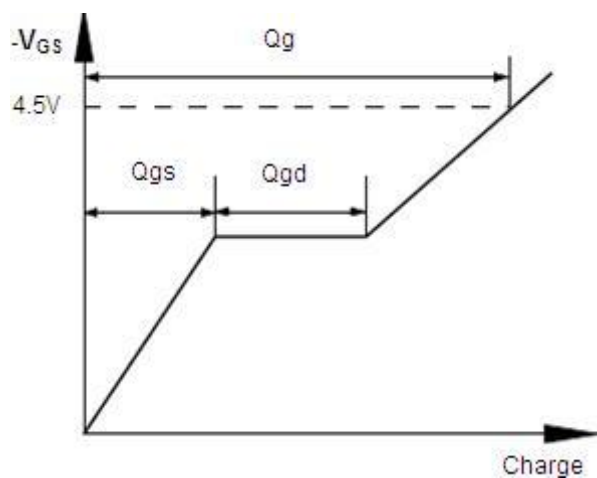
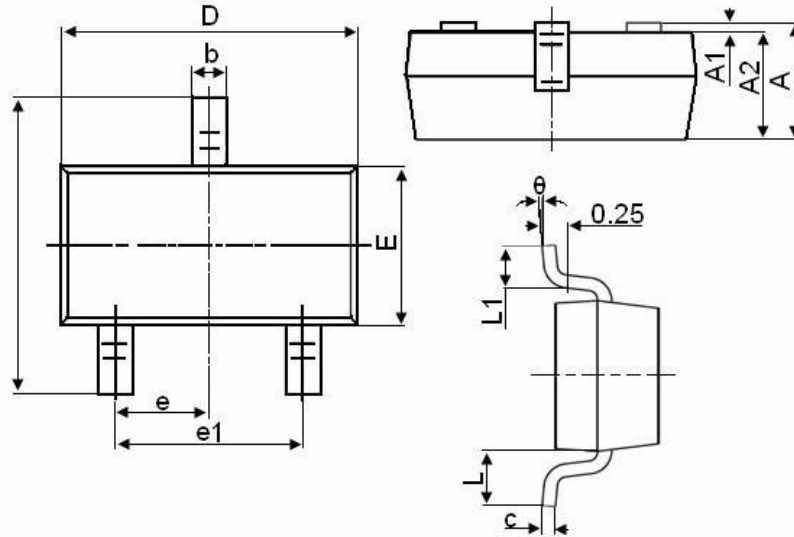


Fig.11 Gate Charge Waveform



**SOT-23- 3L Package Information**



| Symbol | Dimensions in Millimeters |       |
|--------|---------------------------|-------|
|        | MIN.                      | MAX.  |
| A      | 1.050                     | 1.250 |
| A1     | 0.000                     | 0.100 |
| A2     | 1.050                     | 1.150 |
| b      | 0.300                     | 0.500 |
| c      | 0.100                     | 0.200 |
| D      | 2.800                     | 3.000 |
| E      | 1.500                     | 1.700 |
| E1     | 2.650                     | 2.950 |
| e      | 0.950TYP                  |       |
| e1     | 1.800                     | 2.000 |
| L      | 0.550REF                  |       |
| L1     | 0.300                     | 0.600 |
| θ      | 0°                        | 8°    |



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